

DEC 27 2005

Docket No.: 00131-00322-US1
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Dennis W. Prather et al.

Confirmation No.: 4869

Application No.: 10/710,870

Filed: August 9, 2004

Art Unit: 2818

For: METHOD FOR CREATING FLIP-CHIP
CONDUCTIVE-POLYMER BUMPS USING
PHOTOLITHOGRAPHY AND POLISHING

Examiner: C. Lee

REQUEST FOR RECONSIDERATION

MS AF
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Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed August 26, 2005, please amend the above-identified U.S. patent application as follows:

LISTING THE CLAIMS begin on page 2.

REMARKS begin on page 4.